

Crystal LTD TM SPEC Form

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Customer

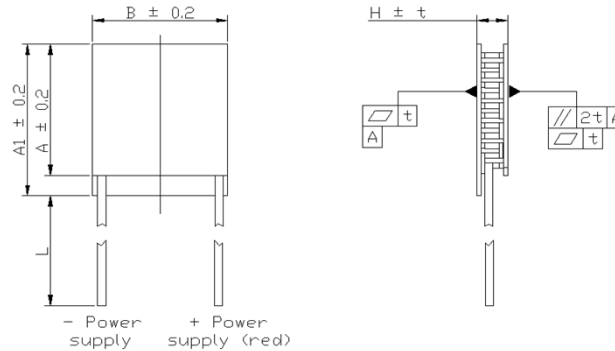
PO#

PO date

Thermoelectric module (TM) specification

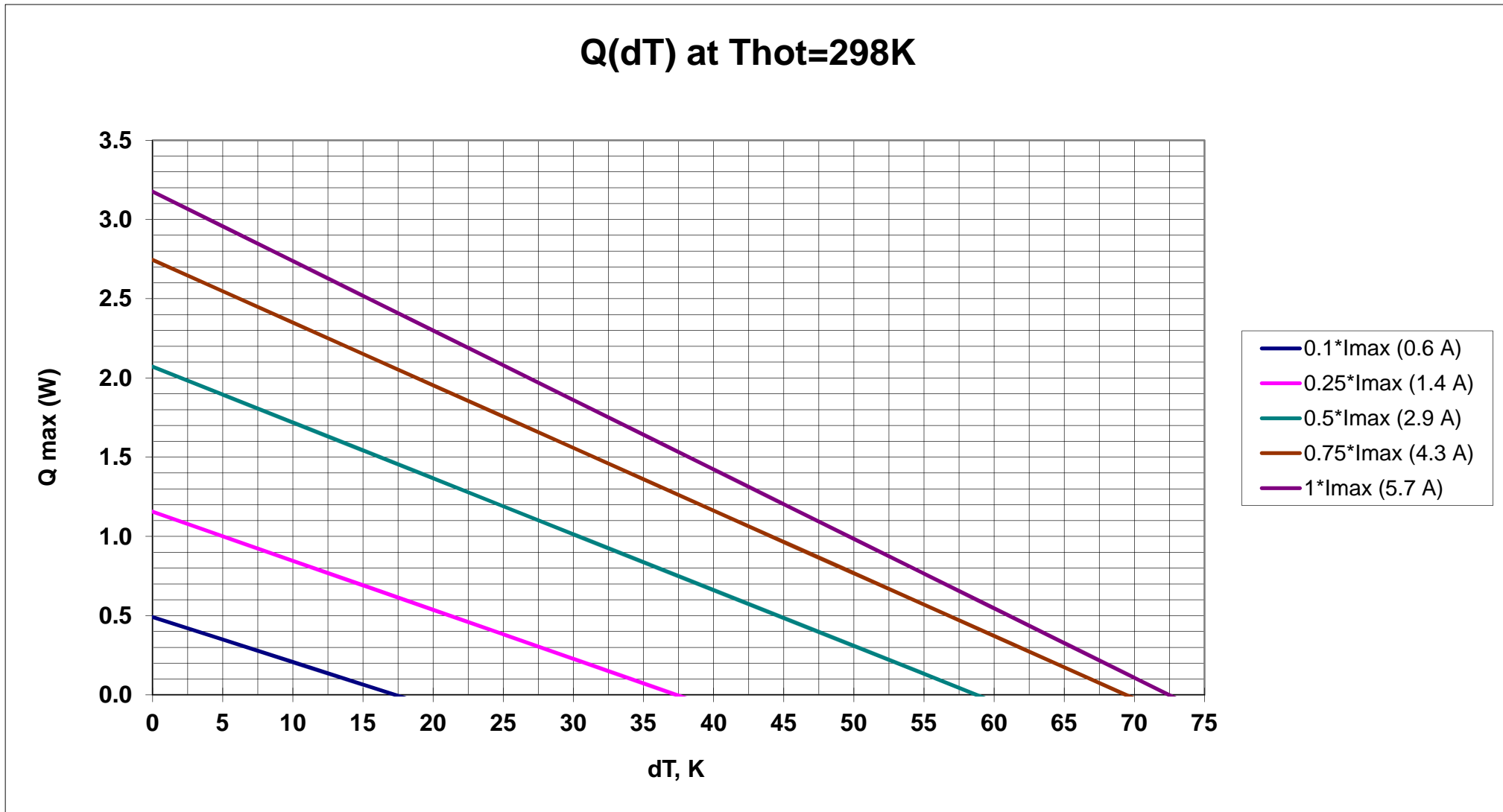
PO position #	TM	Internal Solder Melting Temp, C	Max operating temperature, °C		Parameters in vacuum at hot side temperature 25 °C				Rac at 25 °C		Ceramic size, mm		TM Height		Wire			Sealing
			short time	continuous operation	I _{max} , A	U _{max} , V	Q _{max} , W	dT _{max} , K	Rac, Ohm	Tolerance ±, %	A/A1	B	Height, mm	Tolerance t, ± mm	S, AWG #	Length, mm	Tolerance ±, mm	
1	S-007-10-08	138	130	115	5.7	0.9	3.2	72.5	0.12	10	8/8	8	3.10	0.2	22	100	5	
	lamel version																	
2	H-007-10-08	232	200	150											22	100	5	
	lamel version														PTFE			

Clamping force: 0.8 - 1.7 kg



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Max dT is reduced by 2-3K for silicon sealed and 1-2K for epoxy sealed versions.



U(dT) at $T_{hot}=298K$

